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Dimensions	
Chip Size	2824
L	7.1mm +/-0.4mm
W	6.1mm +/-0.4mm
T	2.5mm +/-0.20mm
S	4.2mm MIN
B	1.27mm +/-0.4mm

Packaging Specifications	
Packaging	Cut Reel
Packaging Quantity	50

General Information	
Series	SMD Indust COG HVHT200C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable, Low Loss
Features	High Temp, Ultra-Stable, Low Loss
RoHS	Yes
Termination	Tin
Marking	false
AEC-Q200	No
Typical Component Weight	540 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.022 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1200 VDC
Temperature Range	-55/+200°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	45.4545 GOhms

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